



Description

The HXY3P06MI uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})}$, This device is suitable

for use as a load switch or in PWM applications.

General Features

 $V_{DS} = -60V, I_{D} = -3A$

 $R_{DS(ON)}$ < 140m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ < 190m Ω @ V_{GS} =-4.5V

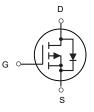
Application

Battery protection

Load switch

Uninterruptible power supply





P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY3P06MI	SOT-23-3L	3P06	3000

Absolute Maximum Ratings (TA=25℃ unless otherwise noted)

Symbol	Parameter	Limit	
V _D s	Drain-Source Voltage	-60	V
Vgs	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	-3	Α
Ірм	Drain Current-Pulsed (Note 1)	-6	А
P _D	Maximum Power Dissipation	1.5	W
T _J ,T _{STG}	Operating Junction and Storage Temperature Range -55 To 150		°C
Rеja	Thermal Resistance, Junction-to-Ambient (Note 2) 85		°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	_{GS} = 0 V , I _D =-250uA	-60			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.049		V/°C
Rds(ON)	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-3A		115	140	mΩ
		V _{GS} =-4.5V , I _D =-2A			190	
V _{GS(th)}	Gate Threshold Voltage	Vcs= V _{DS} , I _D =-250uA	-1.0		-2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			5.42		mV/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-48V , V _{GS} =0V , T _J =25°C			1	- uA
		V _{DS} =-48V , V _{GS} =0V , T _J =150°C			5	
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-3A		5.8		S
Qg	Total Gate Charge (-4.5V)			5.9		
Qgs	Gate-Source Charge	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-3A		2.9		nC
Q_{gd}	Gate-Drain Charge	ate-Drain Charge		1.8		
T _{d(on)}	Turn-On Delay Time	V_{DD} =-12V , V_{GS} =-10V , R_{G} =3.3 Ω ,		10		no
Tr	Rise Time			17		
$T_{d(off)}$	Turn-Off Delay Time	I _D =-3A		22		ns
Tf	Fall Time			21		
Ciss	Input Capacitance			715		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , F=1MHz		51		pF
Crss	Reverse Transfer Capacitance			34		
ls	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current			-3	Α
I _{SM}	Pulsed Source Current ^{2,6}	vg-vb-uv , roice cuiteill			-6	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1.2	V

Note

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V,L=0.1mH, I_{AS} =-20A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



P-Channel Typical Characteristics

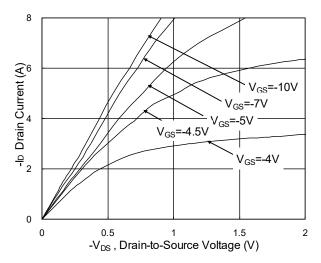


Fig.1 Typical Output Characteristics

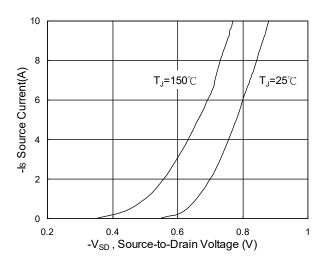


Fig.3 Forward Characteristics Of Reverse

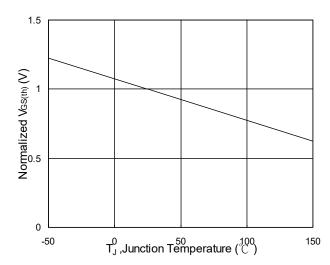


Fig.5 Normalized $V_{\text{GS(th)}}$ vs. T_{J}

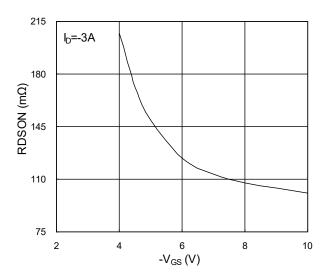


Fig.2 On-Resistance vs. G-S Voltage

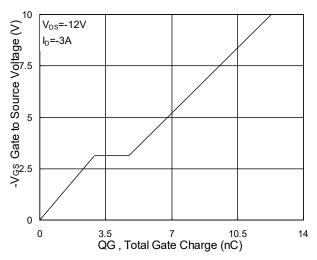


Fig.4 Gate-Charge Characteristics

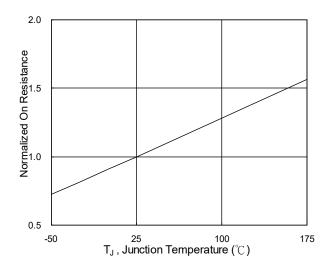
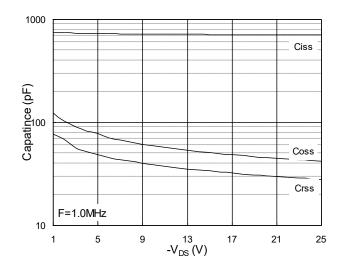


Fig.6 Normalized R_{DSON} vs. T_J





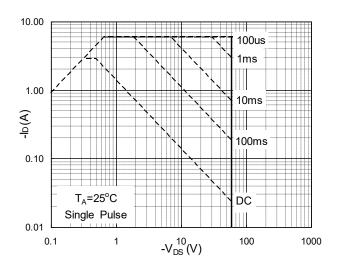


Fig.7 Capacitance

Fig.8 Safe Operating Area

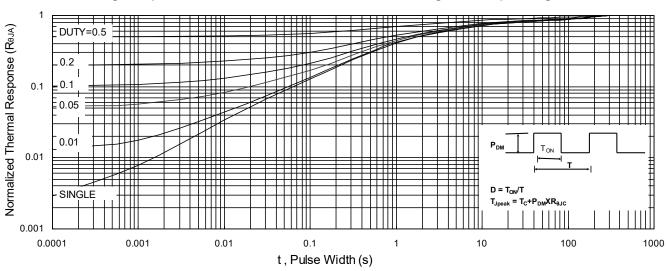
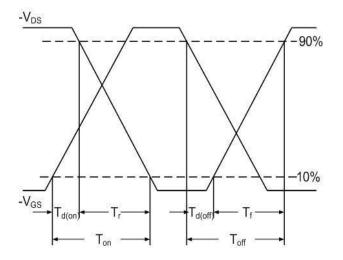


Fig.9 Normalized Maximum Transient Thermal Impedance



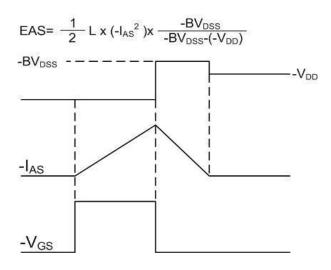
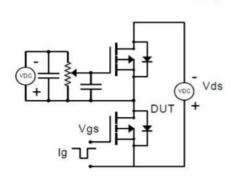


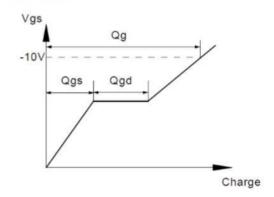
Fig.11 Unclamped Inductive Waveform



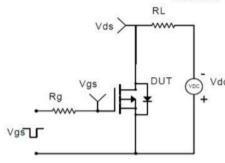
Test Circuit

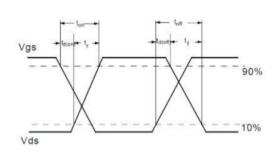
Gate Charge Test Circuit & Waveform



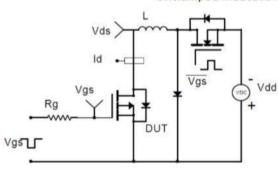


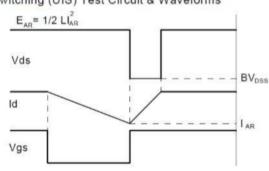
Resistive Switching Test Circuit & Waveforms



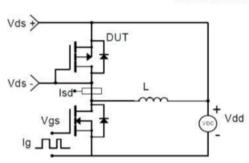


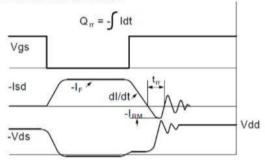
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





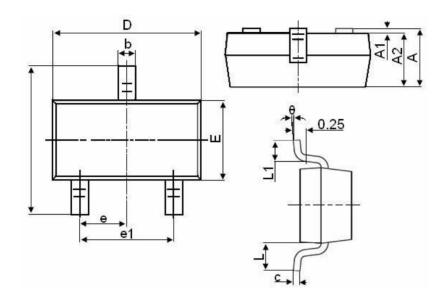
Diode Recovery Test Circuit & Waveforms







SOT-23-3L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	MAX.	
А	1.050	1.250	
A1	0.000	0.100	
A2	1.050	1.150	
b	0.300	0.500	
С	0.100	0.200	
D	2.800	3.000	
E	1.500	1.700	
E1	2.650	2.950	
е		0.950TYP	
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.600	
θ	0°	8°	

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